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STTH60L06TV

Turbo 2 ultrafast high voltage rectifier

Main product characteristics

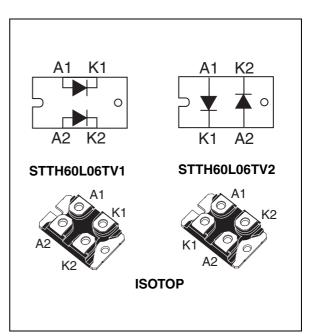
I _{F(AV)}	2 x 40 A
V _{RRM}	600 V
Тj	150° C
V _F (typ)	1.30 V
t _{rr} (typ)	50 ns

Features and benefits

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduces switching & conduction losses
- Insulated package: Electrical insulation = 2500 V_{RMS} Capacitance = 45 pF

Description

The STTH60L06TV, which is using ST Turbo 2 600V technology, is specially suited for use in switching power supplies, and industrial applications (such as welding), as rectification diode.



Order codes

Part Number	Marking
STTH60L06TV1	STTH60L06TV1
STTH60L06TV2	STTH60L06TV2

Table 1. Absolute ratings (limiting values per diode at 25° C, unless otherwise specified)

				,
Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	600	V	
I _{F(RMS)}	RMS forward current	100	А	
1	Average forward current $\delta = 0.5$	30	А	
I _{F(AV)}	Average forward current, $\delta = 0.5$	$T_c = 70^\circ C \text{ per diode}$	40	
I _{FSM}	Surge non repetitive forward current	210	А	
T _{stg}	Storage temperature range	-55 to + 150	°C	
Тj	Maximum operating junction temperature	150	°C	

1 Characteristics

Table 2.	Thermal	parameters

Symbol	Parameter		Value	Unit
P	Junction to case	Per diode	1.60	
R _{th(j-c)}	Total		0.85	°C/W
R _{th(c)}	Coupling thermal resistance		0.1	

When the diodes are used simultaneously:

 $\Delta T_{j(diode1)} = P_{(diode1)} \times R_{th(j-c)} \text{ (per diode)} + P_{(diode2)} \times R_{th(c)}$

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test co	nditions	Min.	Тур	Max.	Unit
I _B ⁽¹⁾	Reverse leakage current	$T_j = 25^\circ C$	V - V			25	μA
IR Preverse leakage current	T _j = 125° C	V _R = V _{RRM}		25	250	μΑ	
V _E ⁽²⁾	Forward voltage drop	$T_j = 25^\circ C$	I _⊏ = 60 A			1.55	v
VF ⁽⁻⁾	Forward voltage drop	T _j = 150° C	1 _F = 60 A		1.0	1.25	v

1. Pulse test: t_p = 5 ms, δ < 2 %

2. Pulse test: t_p = 380 μ s, δ < 2 %

To evaluate the conduction losses use the following equation: P = 0.95 x $I_{F(AV)}$ + 0.010 ${I_F}^2_{(RMS)}$

Table 4. Dynamic characteristics (per diode)

Symbol	Parameter	Test conditions	Min.	Тур	Max.	Unit
+	Reverse recovery time	$I_F = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}$ $I_R = 1 \text{ A}, T_j = 25^{\circ} \text{ C}$			65	ns
t _{rr}		$I_F = 1 \text{ A, } dI_F/dt = 50 \text{ A}/\mu\text{s},$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$		65	90	115
I _{RM}	Reverse recovery current	$I_F = 30$ A, $dI_F/dt = 100$ A/µs, $V_R = 400$ V, $T_j = 125^{\circ}$ C		11.5	16	А
t _{fr}	Forward recovery time	$ I_F = 30 \ A \qquad dI_F/dt = 100 \ A/\mu s \\ V_{FR} = 1.1 \ x \ V_{Fmax}, \ T_j = 25^\circ \ C $			500	ns
V _{FP}	Forward recovery voltage	$I_F = 30 \text{ A, } dI_F/dt = 100 \text{ A/}\mu\text{s},$ $V_{FR} = 1.1 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$		2.5		V



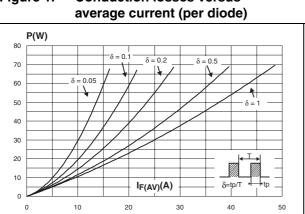


Figure 2. forward current (per diode)

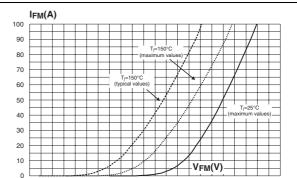
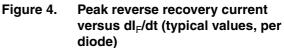
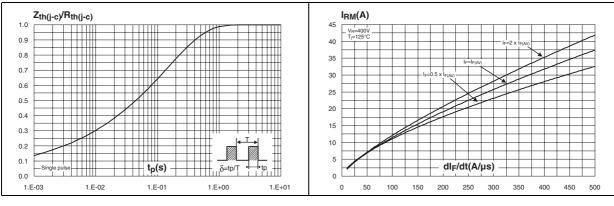


Figure 3. **Relative variation of thermal** impedance junction to case versus pulse duration





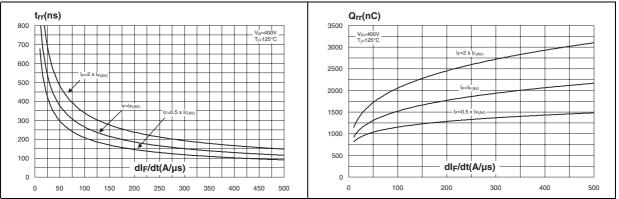
0.0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 1.6 1.8 2.0 2.2

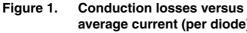
Reverse recovery time versus Figure 5. dl_F/dt (typical values, per diode)

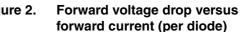
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Figure 6.

Reverse recovery charges versus dl_F/dt (typical values, per diode)







IF=IF(AV) VR=400 125°

125

100

Reverse recovery softness factor Figure 7. versus dl_F/dt (typical values, per diode)

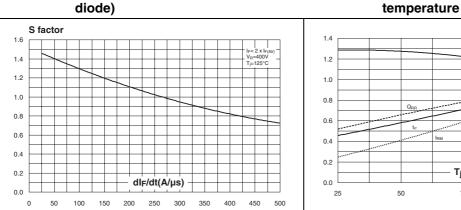


Figure 9. Transient peak forward voltage versus dl_F/dt (typical values, per diode)

Figure 10. Forward recovery time versus dl_F/dt

Tj(°C)

75

ORR

50

(typical values, per diode)

Relative variations of dynamic

parameters versus junction

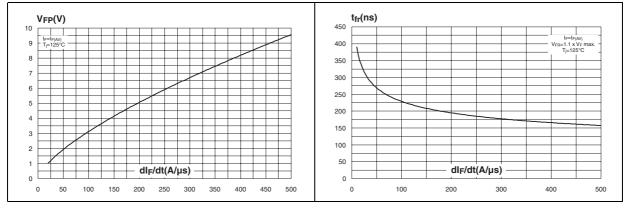
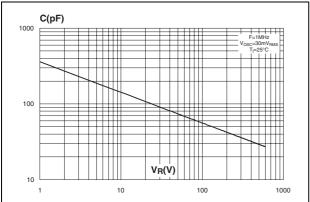


Figure 8.

Figure 11. Junction capacitance versus reverse voltage applied (typical values, per diode)



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2 Package mechanical data

Epoxy meets UL94, V0

Cooling method: by conduction (C)

Table 5. ISOTOP dimensions

		DIMENSIONS				
	REF.	Millimeters		Inc	hes	
		Min.	Max	Min.	Max.	
	Α	11.80	12.20	0.465	0.480	
	A1	8.90	9.10	0.350	0.358	
	В	7.8	8.20	0.307	0.323	
	С	0.75	0.85	0.030	0.033	
	C2	1.95	2.05	0.077	0.081	
	D	37.80	38.20	1.488	1.504	
	D1	31.50	31.70	1.240	1.248	
	Е	25.15	25.50	0.990	1.004	
	E1	23.85	24.15	0.939	0.951	
	E2	24.80 typ.		0.976 typ.		
	G	14.90	15.10	0.587	0.594	
	G1	12.60	12.80	0.496	0.504	
	G2	3.50	4.30	0.138	0.169	
	F	4.10	4.30	0.161	0.169	
	F1	4.60	5.00	0.181	0.197	
	Р	4.00	4.30	0.157	0.69	
	P1	4.00	4.40	0.157	0.173	
	S	30.10	30.30	1.185	1.193	

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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3 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
STTH60L06TV1	STTH60L06TV1	ISOTOP	27 g (without screws)	10 (with screws)	Tube
STTH60L06TV2	STTH60L06TV2	ISOTOP	27 g (without screws)	10 (with screws)	Tube

4 Revision history

Date	Revision	Description of Changes
07-Sep-2004	1	First issue
10-Sep-2004	2	Average forward current (page 1) and Junction to case (page 2) values changed
13-Oct-2006	3	Reformatted to current standard. Added part number STTH60L06TV2.



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